

# 1.2V Drive Nch+Pch MOSFET

## EM6M2

### ●Structure

Silicon N-channel MOSFET /  
Silicon P-channel MOSFET

### ●Features

- 1) Nch MOSFET and Pch MOSFET are put in EMT6 package.
- 2) High-speed switching.
- 3) Low voltage drive (1.2V drive).
- 4) Built-in G-S Protection Diode.

### ●Applications

Switching

### ●Packaging specifications

Type	Package	Taping
	Code	T2R
	Basic ordering unit (pieces)	8000
EM6M2		○

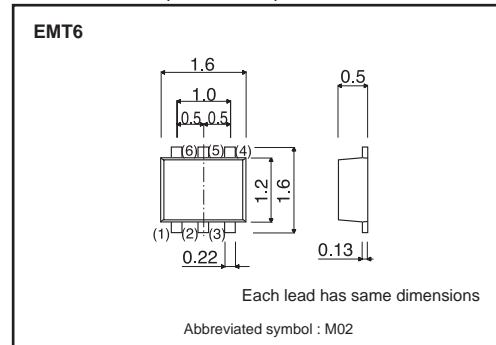
### ●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits		Unit
		Tr1 : N-ch	Tr2 : P-ch	
Drain-source voltage	$V_{DSS}$	20	-20	V
Gate-source voltage	$V_{GSS}$	±8	±10	V
Drain current	Continuous	$I_D$	±200	mA
	Pulsed	$I_{DP}^{*1}$	±400	mA
Total power dissipation	$P_D^{*2}$	150		mW / TOTAL
		120		mW / ELEMENT
Channel temperature	$T_{ch}$	150		°C
Range of storage temperature	$T_{stg}$	-55 to +150		°C

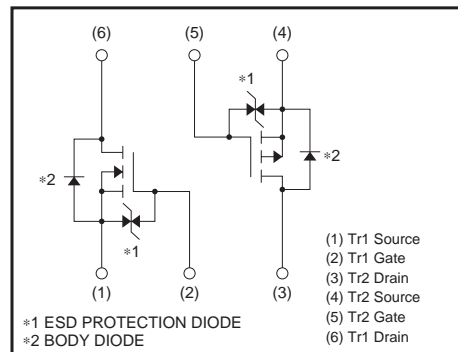
\*1  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*2 Each terminal mounted on a recommended land

### ●Dimensions (Unit : mm)



### ●Inner circuit



## N-ch

## ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	–	–	±10	μA	V <sub>GS</sub> = ±8V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	20	–	–	V	I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	–	–	1	μA	V <sub>DS</sub> = 20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS(th)</sub>	0.3	–	1.0	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain-source on-state resistance	R <sub>DS(on)</sub> *	–	0.7	1.0	Ω	I <sub>D</sub> = 200mA, V <sub>GS</sub> = 4.0V
		–	0.8	1.2	Ω	I <sub>D</sub> = 200mA, V <sub>GS</sub> = 2.5V
		–	1.0	1.4	Ω	I <sub>D</sub> = 200mA, V <sub>GS</sub> = 1.8V
		–	1.2	2.4	Ω	I <sub>D</sub> = 40mA, V <sub>GS</sub> = 1.5V
		–	1.6	4.8	Ω	I <sub>D</sub> = 20mA, V <sub>GS</sub> = 1.2V
Forward transfer admittance	Y <sub>fs</sub>  *	0.2	–	–	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 200mA
Input capacitance	C <sub>iss</sub>	–	25	–	pF	V <sub>DS</sub> = 10V
Output capacitance	C <sub>oss</sub>	–	10	–	pF	V <sub>GS</sub> = 0V
Reverse transfer capacitance	C <sub>rss</sub>	–	10	–	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	–	5	–	ns	V <sub>DD</sub> ≐ 10V
Rise time	t <sub>r</sub> *	–	10	–	ns	I <sub>D</sub> = 150mA
Turn-off delay time	t <sub>d(off)</sub> *	–	15	–	ns	V <sub>GS</sub> = 4.0V
Fall time	t <sub>f</sub> *	–	10	–	ns	R <sub>L</sub> ≐ 67Ω R <sub>G</sub> = 10Ω

\*Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V <sub>SD</sub> *	–	–	1.2	V	I <sub>S</sub> = 100mA, V <sub>GS</sub> =0V

\* Pulsed

## P-ch

## ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	–	–	±10	μA	V <sub>GS</sub> = ±10V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	–20	–	–	V	I <sub>D</sub> = –1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	–	–	–1	μA	V <sub>DS</sub> = –20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS(th)</sub>	–0.3	–	–1.0	V	V <sub>DS</sub> = –10V, I <sub>D</sub> = –100μA
Static drain-source on-state resistance	R <sub>DS(on)</sub> *	–	0.8	1.2	Ω	I <sub>D</sub> = –200mA, V <sub>GS</sub> = –4.5V
		–	1.0	1.5	Ω	I <sub>D</sub> = –100mA, V <sub>GS</sub> = –2.5V
		–	1.3	2.2	Ω	I <sub>D</sub> = –100mA, V <sub>GS</sub> = –1.8V
		–	1.6	3.5	Ω	I <sub>D</sub> = –40mA, V <sub>GS</sub> = –1.5V
		–	2.4	9.6	Ω	I <sub>D</sub> = –10mA, V <sub>GS</sub> = –1.2V
Forward transfer admittance	Y <sub>fs</sub>  *	0.2	–	–	S	V <sub>DS</sub> = –10V, I <sub>D</sub> = –200mA
Input capacitance	C <sub>iss</sub>	–	115	–	pF	V <sub>DS</sub> = –10V
Output capacitance	C <sub>oss</sub>	–	10	–	pF	V <sub>GS</sub> = 0V
Reverse transfer capacitance	C <sub>rss</sub>	–	6	–	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	–	6	–	ns	V <sub>DD</sub> ≐ –10V
Rise time	t <sub>r</sub> *	–	4	–	ns	I <sub>D</sub> = –100mA
Turn-off delay time	t <sub>d(off)</sub> *	–	17	–	ns	V <sub>GS</sub> = –4.5V
Fall time	t <sub>f</sub> *	–	17	–	ns	R <sub>L</sub> ≐ 100Ω R <sub>G</sub> = 10Ω

\*Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V <sub>SD</sub> *	–	–	–1.2	V	I <sub>S</sub> = –200mA, V <sub>GS</sub> =0V

\* Pulsed

N-ch

●Electrical characteristic curve

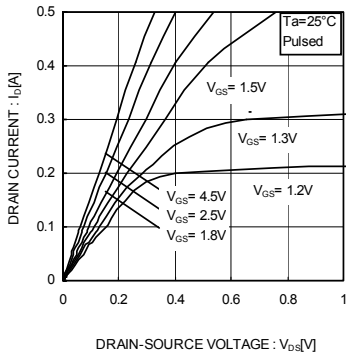


Fig.1 Typical Output Characteristics ( I )

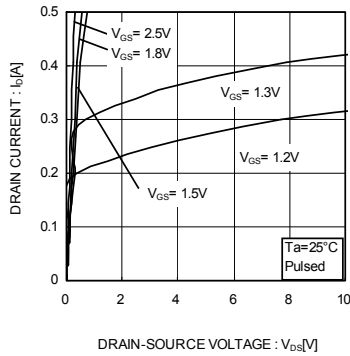


Fig.2 Typical Output Characteristics ( II )

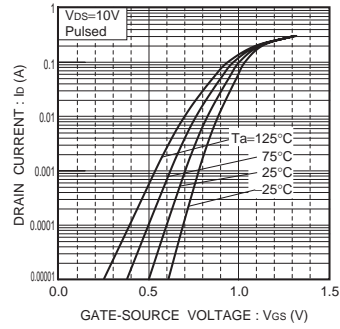


Fig.3 Typical transfer characteristics

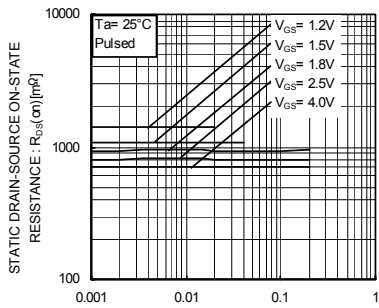


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current( I )

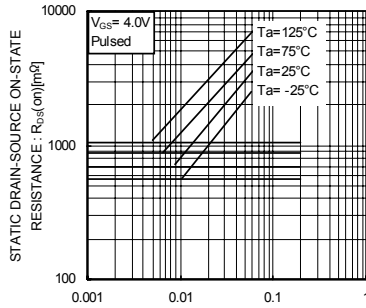


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current( II )

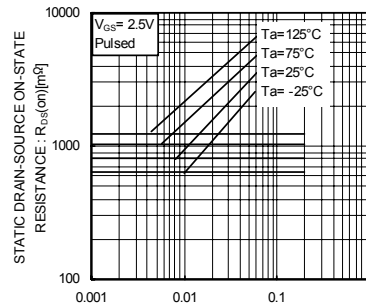


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current( II )

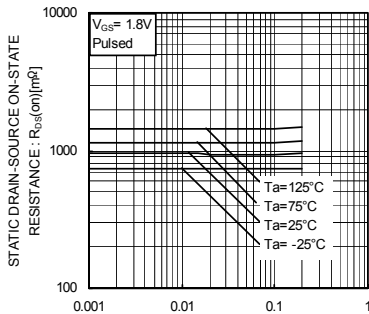


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current( III )

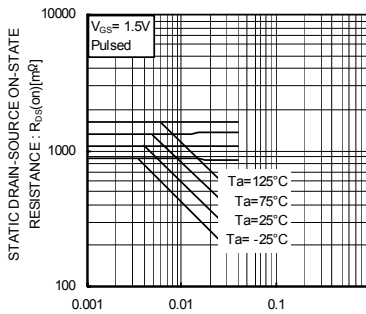


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current( IV )

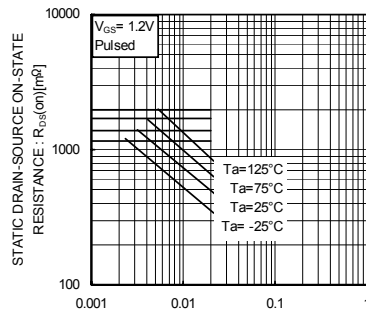


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current( V )

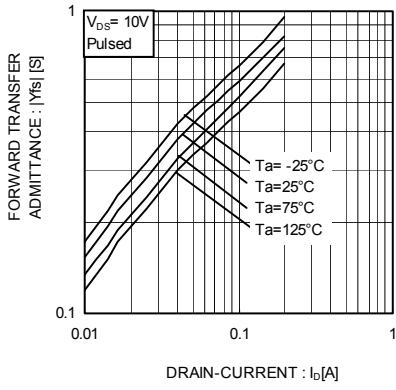


Fig.10 Forward Transfer Admittance vs. Drain Current

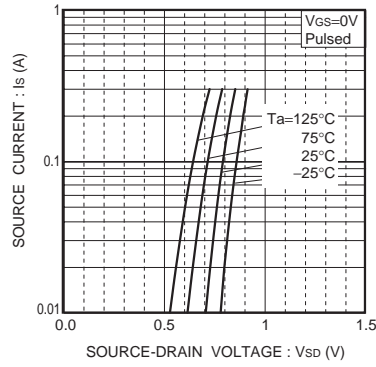


Fig.11 Source current vs. source-drain voltage

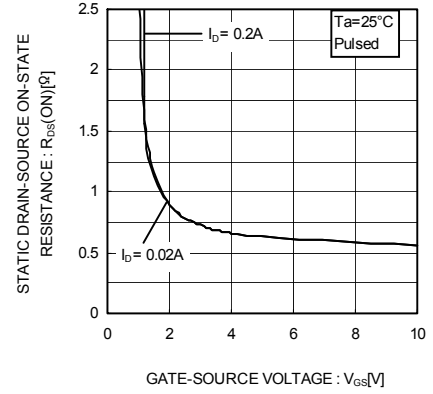


Fig.12 Static Drain-Source On-State Resistance vs. Gate Source Voltage

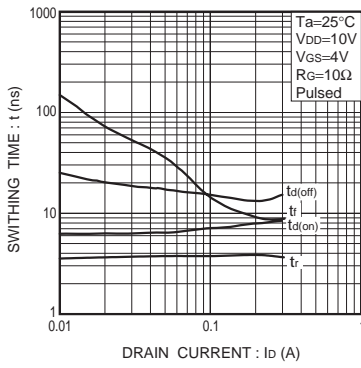


Fig.13 Switching characteristics

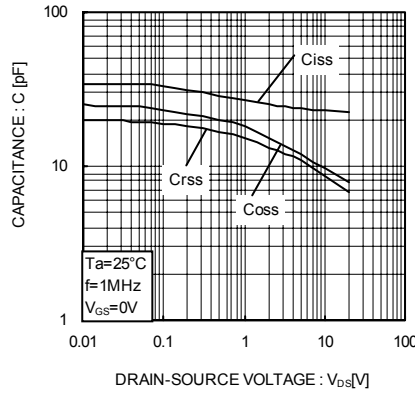


Fig.14 Typical Capacitance vs. Drain-Source Voltage

P-ch

●Electrical characteristic curve

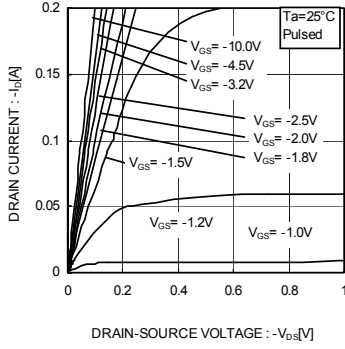


Fig.1 Typical output characteristics ( I )

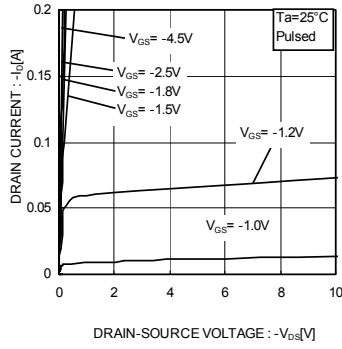


Fig.2 Typical output characteristics ( II )

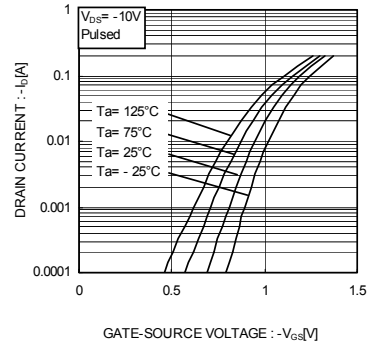


Fig.3 Typical Transfer Characteristics

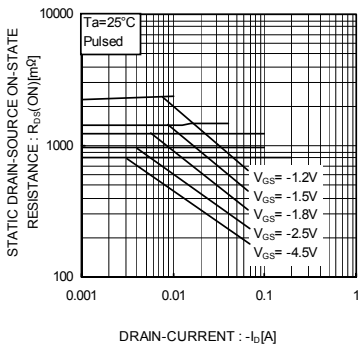


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

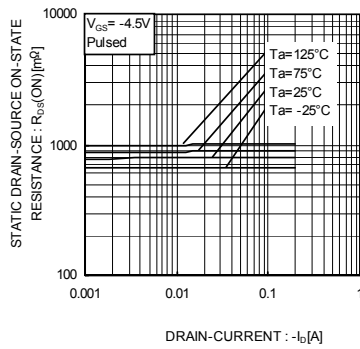


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

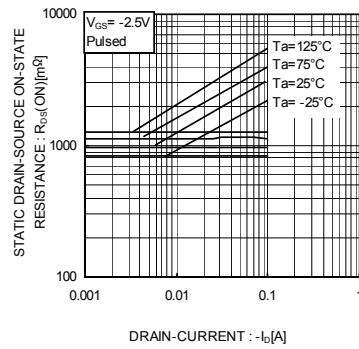


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(III)

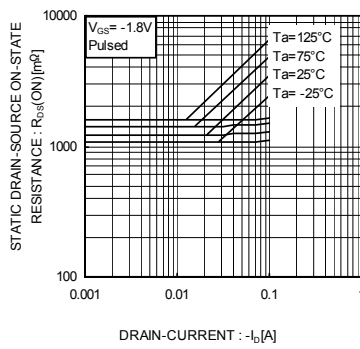


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)

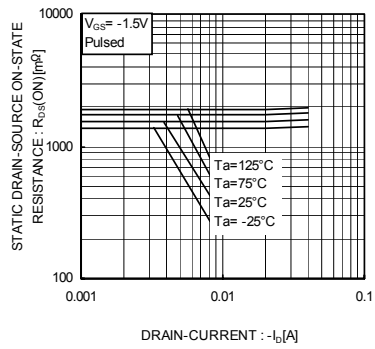


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current(V)

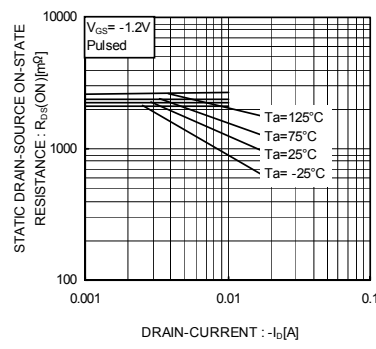


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current(VI)

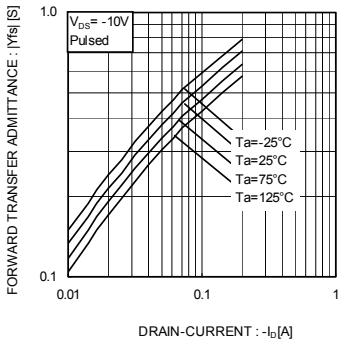


Fig.10 Forward Transfer Admittance vs. Drain Current

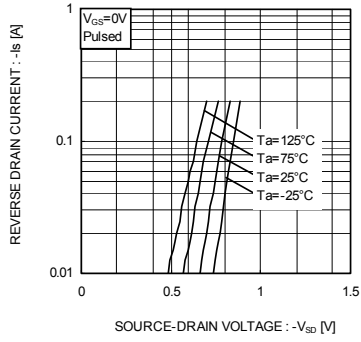


Fig.11 Reverse Drain Current vs. Source-Drain Voltage

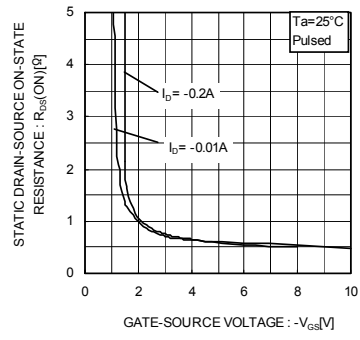


Fig.12 Static Drain-Source On-State Resistance vs. Gate Source Voltage

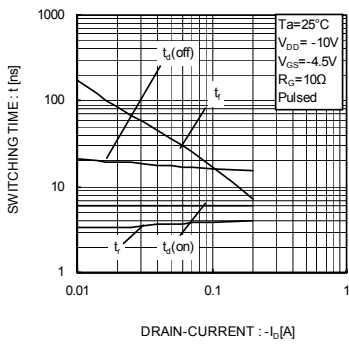


Fig.13 Switching Characteristics

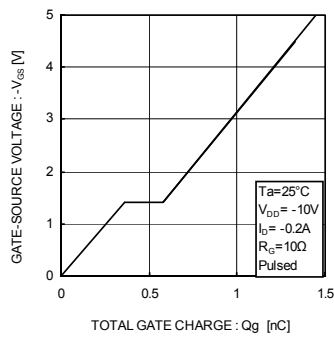


Fig.14 Dynamic Input Characteristics

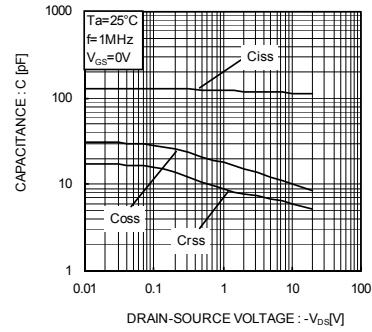


Fig.15 Typical Capacitance vs. Drain-Source Voltage

**N-ch**

**●Measurement circuit**

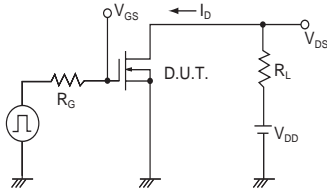


Fig.1-1 Switching Time Measurement circuit

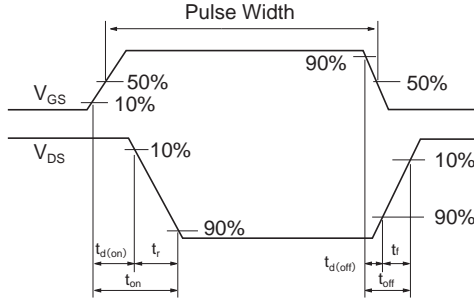


Fig.1-2 Switching Waveforms

**P-ch**

**●Measurement circuit**

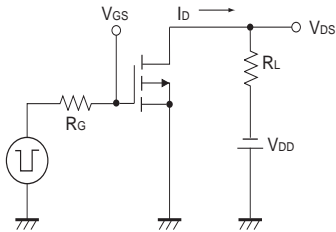


Fig.2-1 Switching Time Measurement circuit

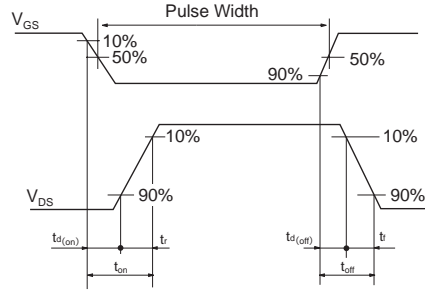


Fig.2-2 Switching Waveforms

**●Notice**

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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